



SFW 1795

PATENT APPLICATION

IN THE U.S. PATENT AND TRADEMARK OFFICE

August 7, 2009

Applicant(s): Katsuyuki TSUCHIDA et al

For: COPPER ELECTROLYTIC SOLUTION CONTAINING AS ADDITIVE  
COMPOUND HAVING SPECIFIC SKELETON, AND ELECTROLYTIC  
COPPER FOIL MANUFACTURED THEREWITH

Serial No.: 10/588 686 Group: 1795

Confirmation No.: 9917

Filed: August 7, 2006 Examiner: Wong

International Application No.: PCT/JP2005/022662

International Filing Date: December 9, 2005

Atty. Docket No.: 4700.P0335US

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

INFORMATION DISCLOSURE STATEMENT

Sir:

In compliance with the provisions of Rules 1.97(b)(3) and 1.98, enclosed herewith is a copy of a Japanese language Office Action dated July 6, 2009, Form PTO-1449 and copies of the foreign references cited thereon.

Also enclosed is a copy of a Japanese language Office Action dated May 8, 2009, Form PTO-1449 and a copy of the reference cited thereon.

Further enclosed is a copy of a Japanese language Office Action dated April 9, 2009, Form PTO-1449 and copies of the references cited thereon. Japanese Patent Publication No. 10-330983 referenced in the Office Action dated April 9, 2009 was previously submitted and therefore is not included herein.

Further consideration is respectfully solicited.

Respectfully submitted,

  
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Terryence F. Chapman

TFC/ad

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Form PTO-1449  
One copy of each foreign cited reference  
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Terryence F. Chapman

110.10/07